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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application of:		)	Group Art Unit: 2823
Shunpei YAMAZAKI et al.			Examiner: William D. Coleman
Serial No. 10/581,674 Filed: June 5, 2006		)	CERTIFICATE OF MAILING I hereby certify that this correspondence is being deposited with the United States Postal
For:	METHOD FOR MANUFACTURING	)	Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on July 7, 2008.
	THIN FILM INTEGRATED CIRCUIT DEVICE, NONCONTACT THIN FILM	)	adum Stamper
	INTEGRATED CIRCUIT DEVICE	)	/
	AND METHOD FOR	)	
	MANUFACTURING THE SAME, AND	)	•
	IDTAG AND COIN INCLUDING THE	)	
	NONCONTACT THIN FILM	)	
	INTEGRATED CIRCUIT	)	·

## <u>AMENDMENT</u>

Honorable Commissioner of Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

In response to the Official Action dated March 5, 2008, please consider the following amendments and remarks in connection with the above-identified application.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims, which begins on page 3 of this paper.

Remarks begin on page 12 of this paper.